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P/N	MFG	Dens	CASE	Interface	Memory Struct	Link
KLM8G1GETF-B041	SAMSUNG	8GB	153FBGA	VDD (1.70V ~ 1.95V or 2.7V ~ 3.6V)	VDC (2.7 3.6V)	link
KLMAG1JETD-B041	SAMSUNG	16GB	153FBGA	VDD (1.70V ~ 1.95V or 2.7V ~ 3.6V)	VDC (2.7 3.6V)	link
KLMBG2JETD-B041	SAMSUNG	32GB	153FBGA	VDD (1.70V ~ 1.95V or 2.7V ~ 3.6V)	VDC (2.7 3.6V)	link
KLMCG4JETD-B041	SAMSUNG	64GB	153FBGA	VDD (1.70V ~ 1.95V or 2.7V ~ 3.6V)	VDC (2.7 3.6V)	link
THGAMRG7T13BAIL	KIOXIA	16GB	153FBGA	VCCQ = 1.7V to 1.95V	VCC 2.7V 3.6V	link

P\N	MFG	Dens	CASE	Interface	Memory	Struct	Link
THGBMNG5D1LBAIL	KIOXIA	4GB	153FBGA	VCCQ = 1.7V to 1.95V / 2.7V to 3.6V	VCC 2.7V 3.6V	Package Vcc(3.3V) C_{VCC} VccQ(1.8V/3.3V) C_{VCCQ} VDDi C_{REG} MMC I/F(1.8V/3.3V) x11 REGULATOR CORE LOGIC MMC I/O BLOCK NAND I/O BLOCK I/O BLOCK NAND NAND Control signal NAND I/O	link